

HS 7541 12-Bit Monolithic Multiplying DAC

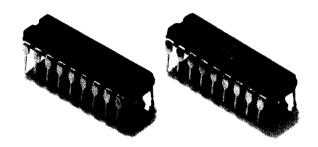
FEATURES

- 12-Bit Linearity
- 2 and 4 Quadrant Multiplication
- 0.5 ppm/°C Gain Error Tempco
- Single Power Supply Operation
- Plug-In Replacement for AD7541 and MP7621
- MIL- versions to MIL-STD-883 Rev. C Available

DESCRIPTION

The HS 7541 is a 12-Bit monolithic digital-to-analog converter featuring a single high-density CMOS chip that includes an advanced resistor network. Linearity of 0.01% is achieved without laser trimming, eliminating a costly manufacturing step while improving stability and reliability.

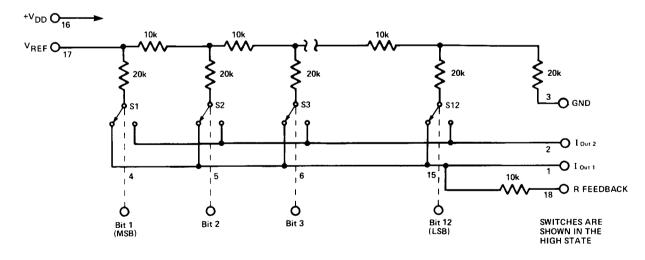
HS 7541 consists of a highly stable thin film R-2R ladder network and twelve CMOS current switches on a monolithic chip. The "ON" resistances of the switches are binarily scaled, so the voltage drop across each switch is identical. This is essential in maintaining the accuracy of the binarily weighted current division performed by the ladder network. The internal feedback resistor used in the output's current-to-voltage conversion operation is matched to the R-2R



ladder and scaled for a maximum gain error of 0.3% F.S.R. Further, special thermal compensation reduces the gain error drift over temperature.

The HS 7541 is a pin and functional equivalent to the AD7541 and MP7621. It meets or exceeds the performance of these devices, with improved supply rejection, improved temperature stability, lower output glitching and lower variation in linearity and gain error with VDD.

FUNCTIONAL DIAGRAM



SPECIFICATIONS

 $(V_{DD} = +15V, V_{REF} = +10V \text{ unless otherwise noted})$

PARAMETER	T _A = +25°C	T _{min} - T _{max}	Test Condition
TYPE	Multiplying		
DIGITAL INPUT			
Resolution 2-Quad. Unipolar Coding 4-Quad. Bipolar Coding Logic Compatibility Logic Thresholds	12-Bits Binary Offset Binary TTL, CMOS		
VINH	2.4V (min)	2.4V (min)	
VINL Input Leakage Current	0.8V (max) ± 1 µ A (max)	0.8V (max) ±1μΑ (max)	$V_{IN} = 0 \text{ or } + 15V$
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REFERENCE INPUT	25V (may)	± 25V (max)	
Voltage Range Input Impedance	±25V (max) 5k Ω (min), 20k (max)	5k Q (min), 20k Q (max)	
ANALOG INPUT	5.K = (,, = 5.K = (,		
Output Current¹ Output Capacity	1mA (nominal)	3 5 6	
Cout 1 Cout 2 Cout 1 Cout 2	200pF (max) 60pF (max) 60pF (max) 200pF (max)	200pF (max) 60pF (max) 60pF (max) 200pF (max)	Digital Inputs = VINH Digital Inputs = VINL
STATIC PERFORMANCE			
Linearity¹ HS 7541-1 HS 7541-2 Gain Accuracy² Output Leakage	±0.024% F.S.R. (max) ±0.012% F.S.R. (max) ±0.3% F.S.R. (max) ±50nA (max)	±0.024% F.S.R. (max) ±0.012% F.S.R. (max) ±0.4% F.S.R. (max) ±200nA (max)	$V_{\text{out 1}} = V_{\text{out 2}} = 0V$ $V_{\text{out 1}} = V_{\text{out 2}} = 0V$ $V_{\text{REF}} = \pm 10V$
DYNAMIC PERFORMANCE			
Output Current Settling to 0.01% Reference Feedthrough Error	1 μ s (max)	1 μ s (max)	
(VREF = 20V _{pp} @ 10kHz)	1mV _{pp} (max)	1mV _{pp} (max)	
STABILITY			War.
Scale Factor Linearity	±2ppm F.S.R./°C (max) ±0.2ppm F.S.R./°C (max)	± 2ppm F.S.R./°C (max) ± 0.2ppm F.S.R./°C (max)	
POWER SUPPLY			
Voltage (V _{DD}) Nominal Range Current - Nominal Rejection Ratio	+ 15V + 5V to + 16V 2mA	+5V to +16V 2mA (max)	Accuracy guaranteed at + 15\ All inputs high or low
(14.5V to 15.5V)	± 0.005%/% (max)	± 0.005%/% (max)	$V_{DD} = 14.5V \text{ to } 15.5V$
TEMPERATURE RANGE			
Operating 7541C-1,-2 7541B-1,-2 Storage		0°C to +70°C -55°C to +125°C -65°C to +150°C	

Do not apply voltages higher than $V_{\mbox{DD}}$ or less than GND potential on any terminal except $V_{\mbox{REF}}$.

The HS 7541 is designed to be used only in those applications where the current output is at virtual ground, i.e., the summing junction of an opamp in the inverting mode. The internal feedback resistor must be used to achieve specified performance.
 Using the internal feedback resistor.

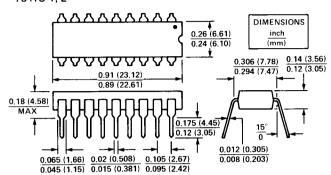
MECHANICAL

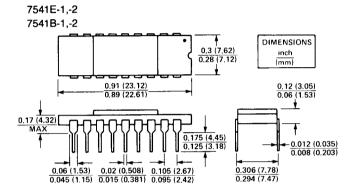
Case Style 7541C-1,-2 7541B-1,-2 18 Pin DIP plastic

ceramic, side braze

Dimensions

7541C-1.-2



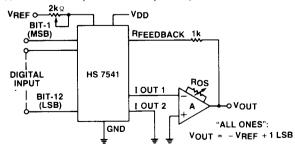


Pin Assignments

PIN	FUNCTION	PIN	FUNCTION
1	OUT 1	18	R FEEDBACK
2	OUT 2	19	V REF
3	GND	16	+V _{DD}
4	Bit 1 (MSB)	15	Bit 12 (LSB)
5	Bit 2	14	Bit 11
6	Bit 3	13	Bit 10
7	Bit 4	12	Bit 9
8	Bit 5	11	Bit 8
9	Bit 6	10	Bit 7

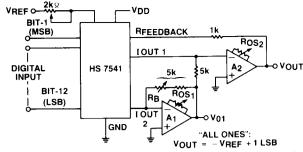
APPLICATIONS INFORMATION

UNIPOLAR OPERATION (2-Quadrant Multiplication)



NOTE: To maintain specified HS 7541 linearity, the external amplifier (A) must be zeroed. Apply an ALL "ZEROS" digital input and adjust ROS for VOUT = 0 ± 1mV.

BIPOLAR OPERATION (4-Quadrant Multiplication)



NOTE: To maintain specified HS 7541 linearity, external amplifiers (A₁ and A₂) must be zeroed. With a digital input of 10...0 and VREF set to zero:

- a) Set ROS1 for V01 = 0
- b) Set ROS2 for VOUT = 0
- c) Set VREF to + 10V and adjust RB for VOUT to be 0 Volts.

UNIPOLAR OPERATION Transfer Characteristics

BIPOLAR OPERATIONTransfer Characteristics

BINARY INPUT	ANALOG OUTPUT	OF BII
111111	-V _{REF} : 4095 4096	111
100001	-V _{REF} 2049 4096	100
100000	- V _{REF} · $\frac{2048}{4096}$	100
011111	-V _{REF} : 2047 4096	011
000001	- V _{REF} · $\frac{1}{4096}$	000
000000	0	000

OFFSET BINARY INPUT	ANALOG OUTPUT	
111111	-V _{REF} : 2047 2048	
100001	-V _{REF} : 1/2048	
100000	0	
011111	V _{REF} : $\frac{1}{2048}$	
000001	V _{REF} : 2047 2048	
000000	VREF	

Formula: V_{OUT} = -V_{REF} · $\frac{N}{4096}$ where N represents the code applied to the DAC

Formula: $V_{OUT} = -V_{REF} \cdot \frac{(N - 2048)}{2048}$ where N represents the code applied to

UNIPOLAR OPERATION

The connections required for digital unipolar operation are shown above. The reference voltage $V_{\mbox{\scriptsize REF}}$ may be either positive or negative. The $2k\Omega$ potentiometer in the $V_{\mbox{\scriptsize REF}}$ line and the $1k\Omega$ resistor in the feedback loop are optional and are only needed when the gain error must be trimmed to less than 0.3% F.S.R. They should track each other to better than 0.1%, but don't have to track 7541's internal network resistors.

BIPOLAR OPERATION

The digital input is offset binary coded and produces an output according to the table above. As with unipolar operation, the gain trim resistors can be omitted in applications accepting a gain error of 0.3% (max).

AMPLIFIER SELECTION

HS 7541 will operate with almost all types of operational amplifiers. However, if certain high speed opamps are selected, the output terminals OUT 1 and OUT 2 should be clamped to ground using Schottky diodes (HP 5082-2811 or equivalent) to prevent OUT 1 or OUT 2 from going negative.

The output resistance of the 7541 varies with the digital input code. The error effect on the output voltage is $2/3~V_{OS}$. Therefore, the offset voltage V_{OS} of the external opamps must be nulled.

For the same reason, the usual bias current compensation resistor in the amplifiers non-inverting input terminal must not be used. Instead, the amplifier should have a low bias current over the operating temperature range and it should not exceed 75mA.

TYPICAL PERFORMANCE CHARACTERISTICS

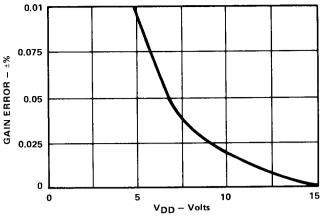


Figure 1. Gain Error vs. Supply Voltage

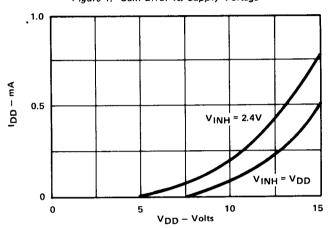


Figure 2. Supply Current vs. Supply Voltage

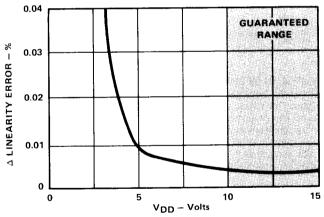


Figure 3. Linearity Error vs. Supply Voltage Typ.

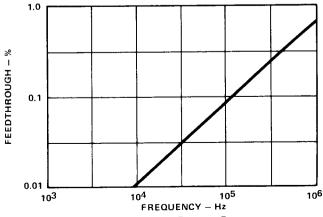


Figure 4. Feedthrough Error vs. Frequency

APPLICATION HINTS

Linearity depends upon the potential at I_{OUt} 1 and I_{Out} 2 (pin 1 and pin 2) being exactly equal to GND (pin 3) and the output amplifier's non-inverting (+) input. Careful PC board layout and adjustment and selection of the amplifier's offset voltage and bias current are necessary.

The input structures of some high speed operational amplifiers can attempt to draw substantial current during switch-on. Schottky diodes should be used in these circumstances to prevent the absolute maximum rating for $V_{out\ 1}$ and $V_{out\ 2}$ being exceeded.

The power supply should be carefully checked for noise, which would affect performance, and overshoot which could damage the device.

Unused digital inputs must always be grounded or taken to VDD to ensure correct operation. Particular care should be taken when digital inputs are routed to another PC card. It is recommended that inputs open-circuited when PC cards are disconnected be taken to VDD or GND via high value (1M Ω) resistors to prevent the accumulation of static charges.

HIGH-RELIABILITY PROCESSING

The MIL-temperature (-55°C to +125°C versions of HS 7541 (i.e. HS 7541B-1 and HS 7541B-2) are manufactured and processed to the requirements of MIL-STD-883B. All units undergo a screening and burn-in in accordance with METHOD 5004. For details contact the factory.

CAUTION: ESD (Electro-Static Discharge) sensitive device. Permanent damage may occur when unconnected devices are subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. Protective foam should be discharged to the destination socket before devices are removed. Devices should be handled at static safe workstations only. Unused digital inputs must be grounded or tied to the logic supply voltage. Unless otherwise noted, the supply voltage at any digital input should never exceed the supply voltage by more than 0.5 volts or go below -0.5 volts. If this condition cannot be maintained, limit input current on digital inputs by using series resistors or contact Hybrid Systems for technical assistance.

ORDERING INFORMATION

MODEL	DESCRIPTION
HS 7541C-1	±0.024% Linearity, 0 to +70° C
HS 7541C-2	±0.012% Linearity, 0 to +70° C
HS 7541B-1	±0.024% Linearity, -55° C to +125° C
HS 7541B-2	±0.012% Linearity, -55° C to +125° C

Specifications subject to change without notice.